



FCP400N80Z — N-Channel SuperFET[®] II MOSFET

FCP400N80Z N-Channel SuperFET[®] II MOSFET 800 V, 14 A, 400 mΩ

Features

• Typ. R_{DS(on)} = 340 mΩ

FAIRCHILD

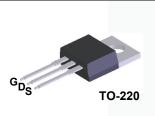
- Ultra Low Gate Charge (Typ. Q_q = 43 nC)
- Low E_{oss} (Typ. 4.1 uJ @ 400 V)
- Low Effective Output Capacitance (Typ. C_{oss(eff.)} = 138 pF)
- 100% Avalanche Tested
- RoHS Compliant
- · ESD Improved Capability

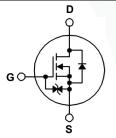
Applications

- AC-DC Power Supply
- LED Lighting

Description

SuperFET[®] II MOSFET is Fairchild Semiconductor's brand-new high voltage super-junction (SJ) MOSFET family that is utilizing charge balance technology for outstanding low on-resistance and lower gate charge performance. This technology is tailored to minimize conduction loss, provide superior switching performance, dv/dt rate and higher avalanche energy. In addition, internal gate-source ESD diode allows to withstand over 2kV HBM surge stress. Consequently, SuperFET II MOSFET is very suitable for the switching power applications such as Audio, Laptop adapter, Lighting, ATX power and industrial power applications.





Absolute Maximum Ratings T_C = 25°C unless otherwise noted.

Symbol		Parameter	FCP400N80Z	Unit		
V _{DSS}	Drain to Source Voltage		800	V		
V _{GSS}		- DC	- DC		V	
	Gate to Source Voltage	- AC	(f >1 Hz)	±30	- V	
ID	Drain Current	- Continuous (T _C = 25 ^o C)		14	A	
		- Continuous (T _C = 100 ^o C)		8.9		
I _{DM}	Drain Current	- Pulsed (Note 1)		33	A	
E _{AS}	Single Pulsed Avalanche Ene	(Note 2)	339	mJ		
I _{AR}	Avalanche Current	(Note 1)	2.2	A		
E _{AR}	Repetitive Avalanche Energy	(Note 1)	1.95	mJ		
dv/dt	MOSFET dv/dt		100	Mag		
	Peak Diode Recovery dv/dt (Note 3)			20	V/ns	
P _D	Power Dissipation	(T _C = 25°C)		195	W	
	Fower Dissipation	- Derate Above 25°C		1.56	W/ºC	
T _J , T _{STG}	Operating and Storage Temp	erature Range	-55 to +150	°C		
Τ _L	Maximum Lead Temperature for Soldering, 1/8" from Case for 5 Seconds			300	°C	

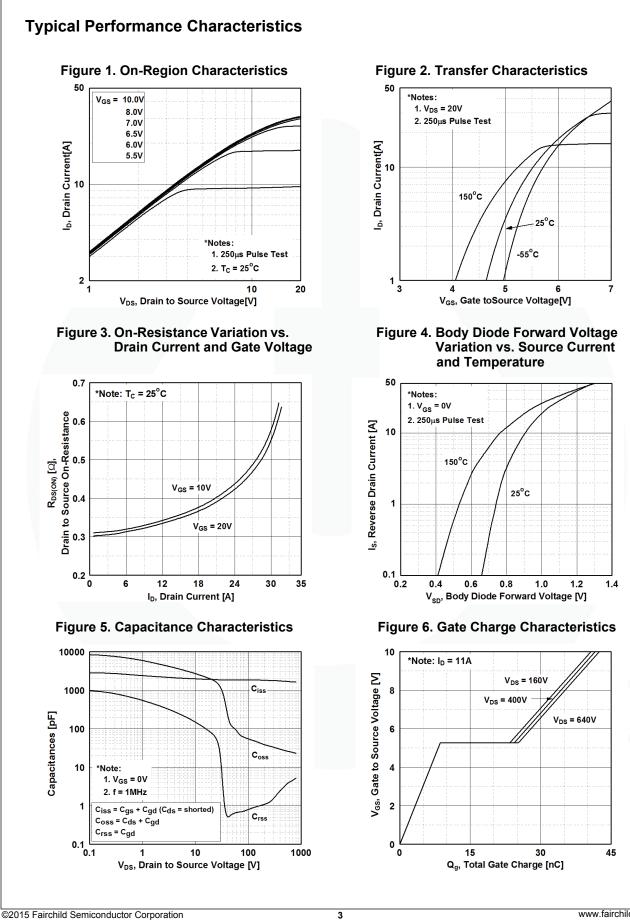
Thermal Characteristics

Symbol	Parameter	FCP400N80Z	Unit
$R_{\theta JC}$	Thermal Resistance, Junction to Case, Max.	0.64	°C/W
R_{\thetaJA}	Thermal Resistance, Junction to Ambient, Max.	62.5	°C/VV

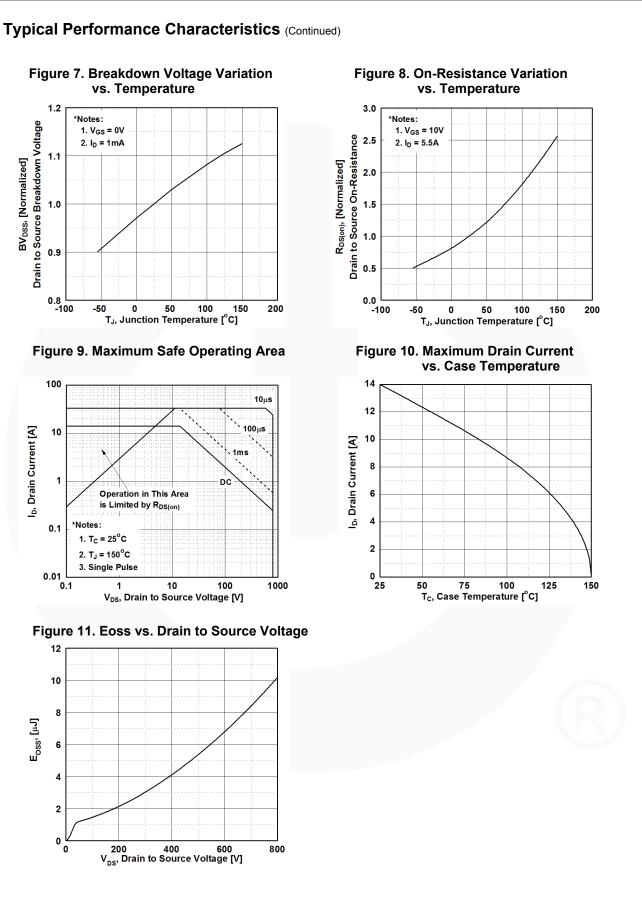
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Part NU	umber	Top Mark	Package	Packing Method	d Reel Siz	e T	ape Width	ו Qu	antity	
FCP400	•		TO-220	Tube	N/A		N/A	50	50 units	
Electrica	al Char	acteristics T _C = 25 ^c	^o C unless o	therwise noted.						
Symbol		Parameter		Test Conditions		Min.	Тур.	Max.	Unit	
Off Chara	cteristic	S	- <u>(</u>							
BV _{DSS}	Drain to	Source Breakdown Voltag	ge V _{GS} = 0 V, I _D = 1 mA, T _J = 25°C		800	-	-	V		
ΔBV_{DSS} / ΔT_J	Breakdo Coefficie	wn Voltage Temperature ent		$I_D = 1$ mA, Referenced to 25°C		-	0.8	-	V/ºC	
I _{DSS}	Zero Ga	te Voltage Drain Current		V_{DS} = 800 V, V_{GS} = 0 V		-	-	25	μA	
USS	2010 00	Zero Gate Voltage Drain Current		V _{DS} = 640 V, T _C = 125°C		-	-	250	μΑ	
I _{GSS}	Gate to Body Leakage Current $V_{GS} = \pm 20 \text{ V}, V_{DS} = 0 \text{ V}$		V	-	-	±10	μA			
On Chara	cteristics	S								
V _{GS(th)}	Gate Threshold Voltage		V	$V_{GS} = V_{DS}, I_{D} = 1.1 \text{ mA}$		2.5	-	4.5	V	
R _{DS(on)}	Static D	rain to Source On Resista	nce V	/ _{GS} = 10 V, I _D = 5.5 A		-	0.34	0.4	Ω	
9 _{FS}	Forward	Forward Transconductance		$V_{DS} = 20 \text{ V}, I_D = 5.5 \text{ A}$			12	-	S	
Dynamic	Characte	eristics					1		1	
C _{iss}	Input Ca	pacitance		V _{DS} = 100 V, V _{GS} = 0 V, f = 1 MHz		-	1770	2350	pF	
C _{oss}	Output C	Capacitance				-	51	70	pF	
C _{rss}	Reverse	Transfer Capacitance	T			-	0.5	-	pF	
C _{oss}	Output 0	Output Capacitance		V _{DS} = 480 V, V _{GS} = 0 V, f = 1 MHz			28	-	pF	
C _{oss(eff.)}	Effective Output Capacitance			$V_{DS} = 0 V \text{ to } 480 V, V_{GS} = 0 V$		-	138	-	pF	
Q _{g(tot)}	Total Ga	te Charge at 10V	\ \	/ _{DS} = 640 V, I _D = 11 A	۹.	-	43	56	nC	
Q _{gs}	Gate to	Source Gate Charge		V _{GS} = 10 V (Note 4)		-	8.6	-	nC	
Q _{gd}	Gate to	Drain "Miller" Charge				-	17	-	nC	
EŠR	Equivale	ent Series Resistance	f			-	2.3	-	Ω	
Switching	g Charac	teristics								
t _{d(on)}	Turn-On	Delay Time		V_{DD} = 400 V, I _D = 11 A, V _{GS} = 10 V, R _g = 4.7 Ω		-	20	50	ns	
t _r	Turn-On	Rise Time				- /	12	34	ns	
t _{d(off)}	Turn-Off	Delay Time	V			-	51	112	ns	
t _f	Turn-Off	Fall Time		(Note 4)			2.6	15	ns	
Drain-Soເ	urce Dioc	le Characteristics						1		
I _S	Maximum Continuous Drain to Source Diode Forward Current				-	-	14	A		
I _{SM}	Maximum Pulsed Drain to Source Diode F			Forward Current		-	-	33	A	
	Drain to Source Diode Forward Voltage		oltage V	V _{GS} = 0 V, I _{SD} = 11 A		-	/	1.2	V	
V _{SD}	Reverse Recovery Time		V	$V_{GS} = 0 V, I_{SD} = 11 A,$		-	395	-	ns	
V _{SD} t _{rr}				dI _F /dt = 100 A/μs			7.4	-	μC	



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1.1

1.0

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100

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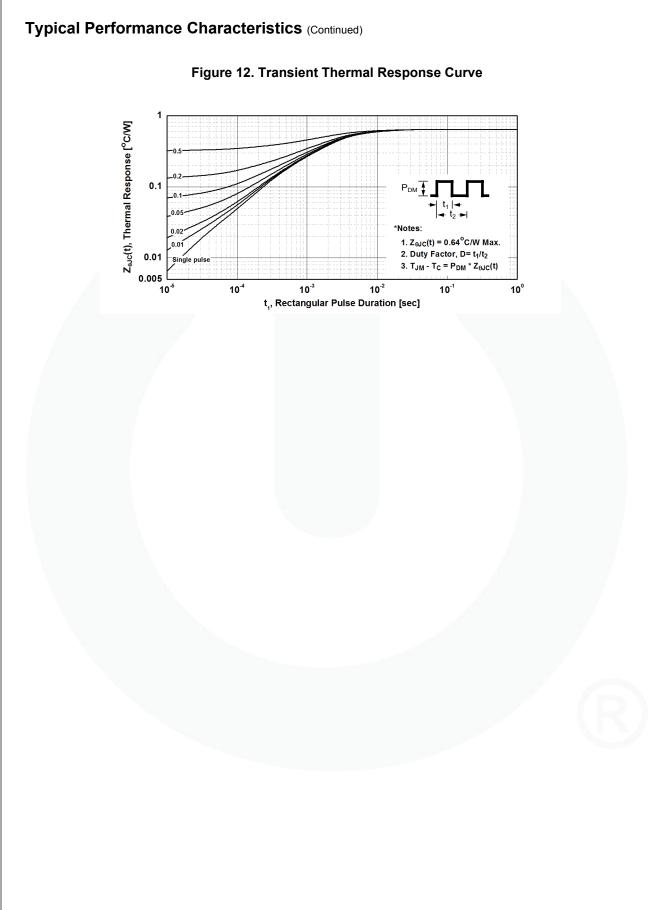
E_{oss}, [µJ] 6

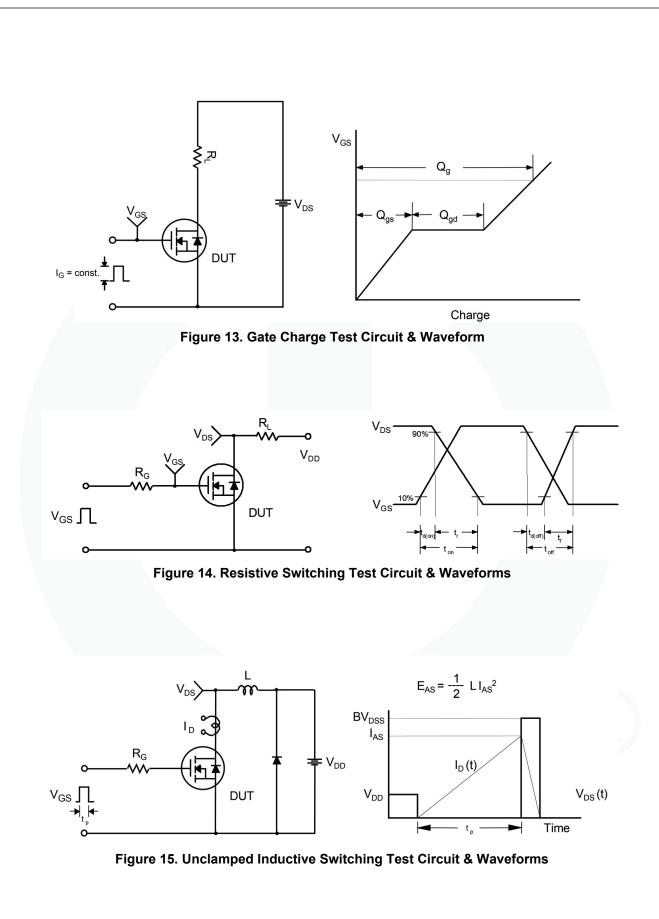
Drain Current [A]

ف

Drain to Source Breakdown Voltage

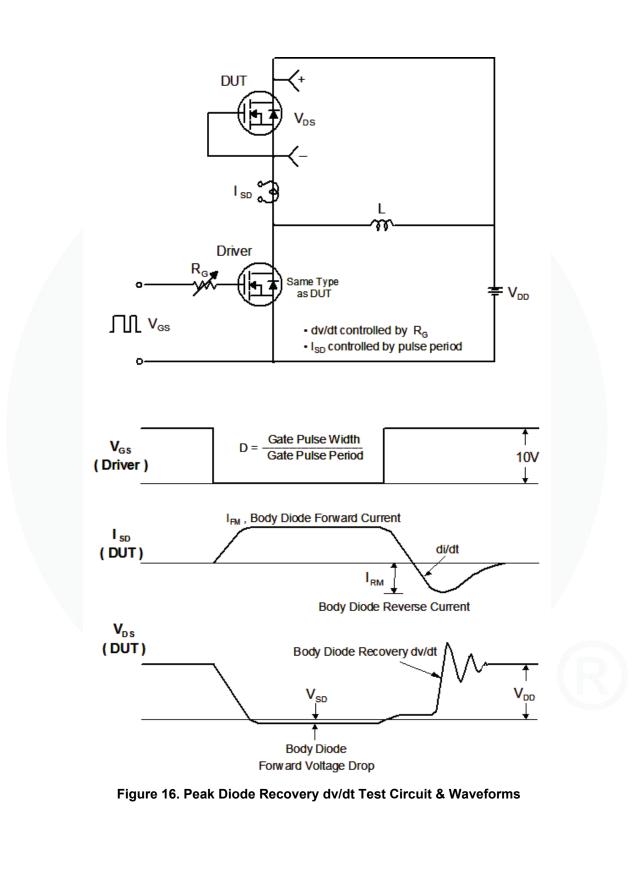
BV_{DSS}, [Normalized]

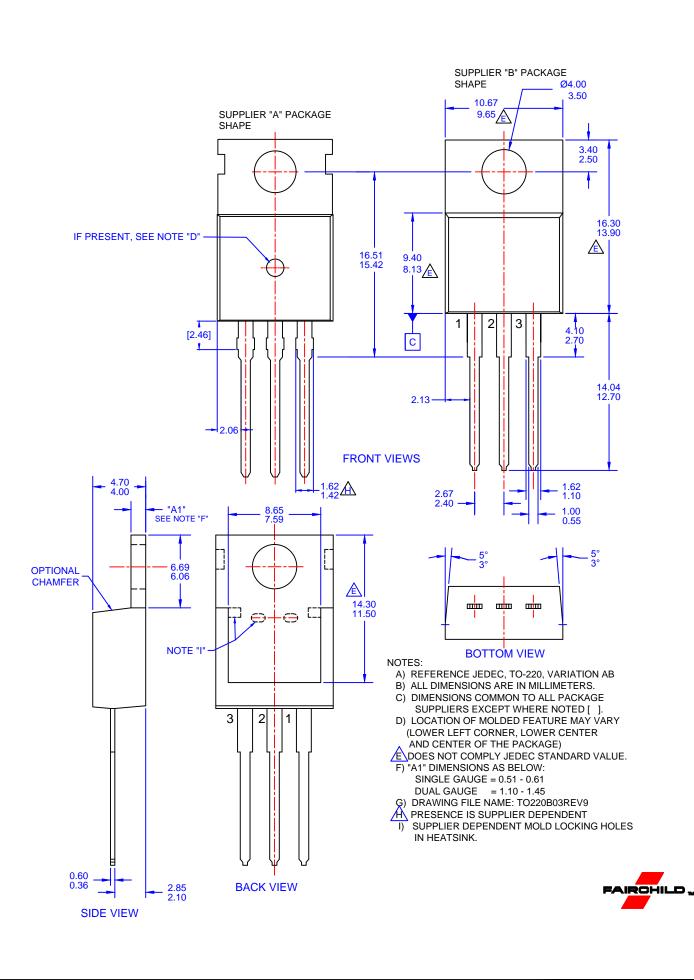




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